



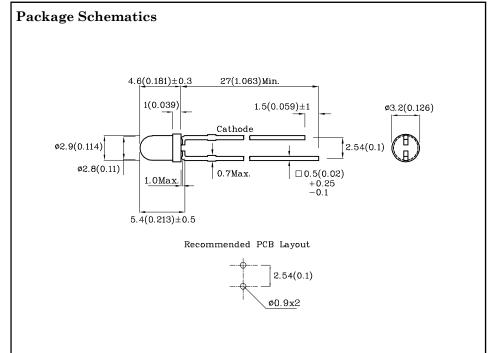
T-1 (3mm) Infrared Emitting Diode

Features

- Radial / Through hole package
- \bullet Reliable & robust
- Low power consumption
- Available on tape and reel
- Halogen-free
- RoHS Compliant







Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		TNI (GaAs)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V		
Forward Current	I_{F}	50	mA		
Forward Current (Peak) 1/100 Duty Cycle 10µs Pulse Width	iFS	1200	mA		
Power Dissipation	P_{D}	90	mW		
Operating Temperature	$T_{\rm A}$	T _A -40 ~ +85			
Storage Temperature	Tstg	-40 ~ +85	°C		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		TNI (GaAs)	Unit
Forward Voltage (Typ.) (I _F =20mA)	$ m V_F$	1.2	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	1.6	V
Reverse Current (Max.) $(V_R=5V)$	$I_{ m R}$	10	μА
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λΡ	940*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	50	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	90	pF

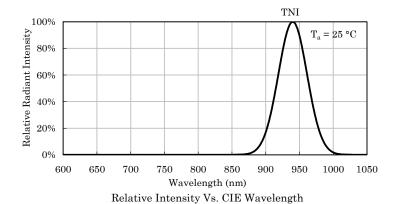
	Part Number	Emitting Material	Lens-color	Radiant Intensity (Po=mW/sr) CIE127-2007* @20mA		nW/sr) (Po=mW/sr) 7-2007* CIE127-2007*		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.	min.	typ.		
XTNI11W	VTNII 1 W	GaAs	Water Clear	5	9	18	31	- 940*	30°
	GaAs	water Clear	3*	7*	12*	24*	940	50	

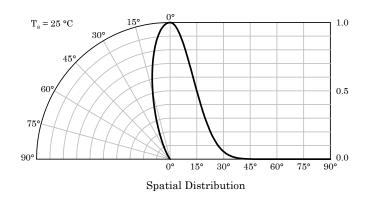
^{*}Radiant intensity value and wavelength are in accordance with CIE127-2007 standards.

Mar 07,2023 XDSB2496 V3-X Layout: Maggie L.

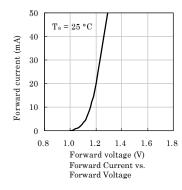


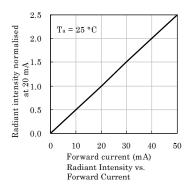


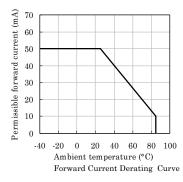


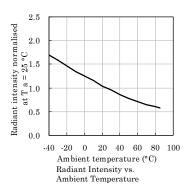


❖ TNI

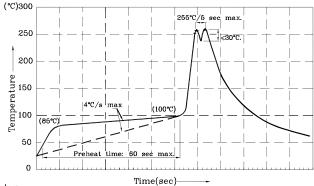








Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



Notes: Notes. I. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of $260^{\circ}C$ 2. Peak wave soldering temperature between $245^{\circ}C \sim 255^{\circ}C$ for 3 sec

(5 sec max).

 $3.\mathrm{Do}$ not apply stress to the epoxy resin while the temperature is above $85^{\circ}\mathrm{C}$. $4.\mathrm{Fixtures}$ should not incur stress on the component when mounting and

during soldering process. 5.SAC 305 solder alloy is recommended.

6. No more than one wave soldering pass.

Remarks:

If special sorting is required (e.g. binning based on forward voltage or radiant intensity / luminous flux),

the typical accuracy of the sorting process is as follows:

1. Radiant Intensity / Luminous Flux: +/-15%

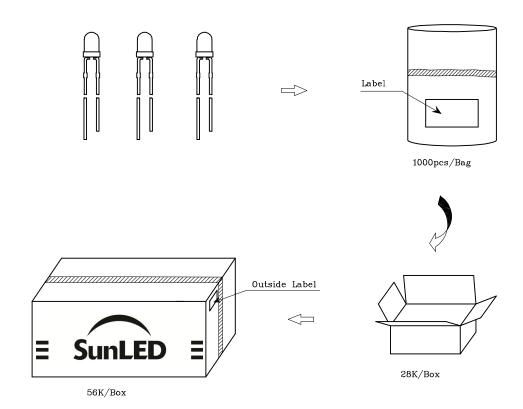
2. Forward Voltage: +/-0.1V

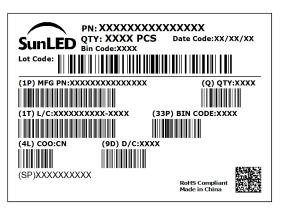
Note: Accuracy may depend on the sorting parameters





PACKING & LABEL SPECIFICATIONS





TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The performance of the product(s) should be evaluated and verified by the customer to ensure it can meet the customer's application requirements.
- 6. The contents within this document may not be altered without prior consent by SunLED.
- $7.\ Additional\ technical\ notes\ are\ available\ at\ \underline{https://www.SunLEDusa.com/TechnicalNotes.asp}$

Mar 07,2023